

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIV)

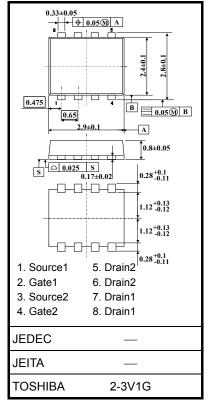
TPCP8302

Lithium Ion Battery Applications Notebook PC Applications Portable Equipment Applications

- Lead (Pb)-free
- Small footprint due to small and thin package
- Low drain-source ON-resistance: $R_{DS(ON)} = 25 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: |Y_{fs}| = 14 S (typ.)
- Low leakage current: $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -20 \ V)$
- Enhancement model: V_{th} = -0.4 to -1.0V (V_{DS} = -6 V, I_D = -1 mA)

Cha	racteristic	Symbol	Rating	Unit	
Drain-source voltage	ge	V _{DSS}	-20	V	
Drain-gate voltage	$(R_{GS} = 20 \text{ k}\Omega)$	V _{DGR}	-20	V	
Gate-source voltag	je	V _{GSS}	±12	V	
Drain current	DC (Note 1)	Ι _D	-5	•	
Drain current	Pulse (Note 1)	I _{DP}	-20	A	
Drain power dissipation (t = 5 s) (Note 2a)	Single-device operation (Note 3a)	P _{D (1)}	1.48	W	
	Single-device value at dual operation (Note 3b)	P _{D (2)}	1.23		
Drain power dissipation	Single-device operation (Note 3a)	P _{D (1)}	0.58		
(t = 5 s) (Note 2b)	Single-device value at dual operation (Note 3b)	P _{D (2)}	0.36		
Single-pulse avala	nche energy (Note 4)	E _{AS}	6.5	mJ	
Avalanche current		I _{AR}	-5	А	
	petitive avalanche energy ngle-device value at dual operation (Note 2a, 3b, 5)			mJ	
Channel temperatu	ire	T _{ch}	150	°C	
Storage temperatu	re range	T _{stg}	-55 to 150	°C	

Absolute Maximum Ratings (Ta = 25°C)



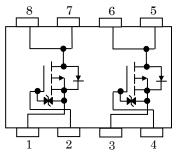
Weight: 0.017 g (typ.)

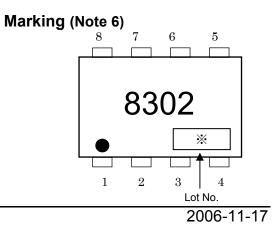
Note: For Notes 1 to 6, see the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

This transistor is an electrostatic-sensitive device. Handle with care.

Circuit Configuration





Unit: mm

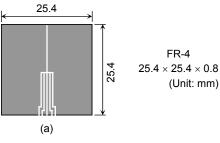
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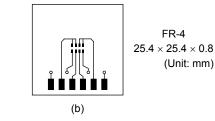
Thermal Characteristics

Chara	cteristic	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	84.5	°C/W	
	Single-device value at dual operation (Note 3b)	R _{th (ch-a) (2)}	101.6		
Thermal resistance,	Single-device operation (Note 3a)			°C/W	
channel to ambient (t = 5 s) (Note 2b)	Single-device value at dual operation (Note 3b) Rth (ch-a) (2) 347.2		347.2		

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)





(b) Device mounted on a glass-epoxy board (b)

Note 3: a) The power dissipation and thermal resistance values shown are for a single device. (During single-device operation, power is applied to one device only.)

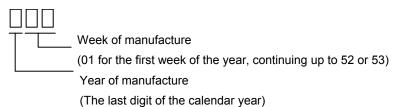
b) The power dissipation and thermal resistance values shown are for a single device. (During dual operation, power is applied to both devices evenly.).

Note 4: $V_{DD} = -16 \text{ V}$, $T_{ch} = 25^{\circ}C$ (initial), L = 0.2 mH, $R_G = 25 \Omega$, $I_{AR} = -5 \text{ A}$

Note 5: Repetitive rating: Pulse width limited by Max. Channel temperature.

Note 6: • on the lower left of the marking indicates Pin 1.

* Weekly code (3 digits):



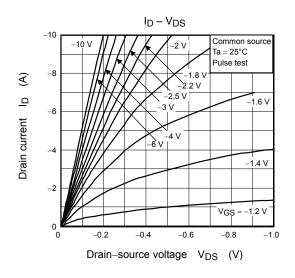
Electrical Characteristics (Ta = 25°C)

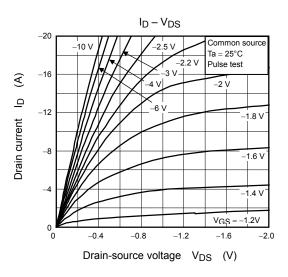
Ch	aracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rrent	I _{GSS}	$V_{GS}=\pm 10~V,~V_{DS}=0~V$	_		±10	μA
Drain cutoff curre	ent	I _{DSS}	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	— — — — — — 10		-10	μA
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-20	_	_	V
Diam-source bie	ain-source breakdown voltage		$I_D = -10$ mA, $V_{GS} = 12$ V	-8	_	—	v
Gate threshold ve	oltage	V _{th}	$V_{DS} = -6 V, I_D = -1 mA$	-0.4		-1.0	V
		R _{DS (ON)}	$V_{GS} = -1.8 \text{ V}, I_D = -0.3 \text{ A}$	_	50	95	
Drain-source ON-resistance		R _{DS (ON)}	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -2.5 \text{ A}$	_	33	45	mΩ
		R _{DS (ON)}	$V_{GS} = -4 V, I_D = -2.5A$		25	33	
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	7	14	_	S
Input capacitance		C _{iss}		_	1500	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	_	220		
Output capacitance		C _{oss}		_	240		
Switching time	Rise time	tr	$V_{GS} \stackrel{0V}{\xrightarrow{-5V}} \stackrel{I_D = -2.5A}{\xrightarrow{I_D = -2.5A}} OUT$	_	10	_	
	Turn-on time	t _{on}		_	20	_	
	Fall time	t _f		_	65	_	ns
	Turn-off time	t _{off}		—	200	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -16 \text{ V}, \text{ V}_{GS} = -5 \text{ V},$	_	20	_	
Gate-source charge1		Q _{gs1}	$I_{\rm D} = -5 \rm{A}$	_	3.6		nC
Gate-drain ("Miller") charge		Q _{gd}]	_	5.1		

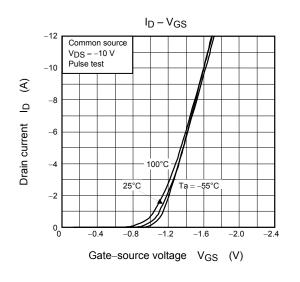
Source-Drain Ratings and Characteristics (Ta = 25°C)

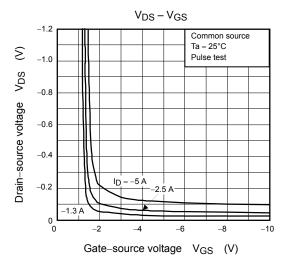
Characteris	tic	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	_	_	-20	А
Forward voltage (diode)		V _{DSF}	$I_{DR} = -5 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		_	1.2	V

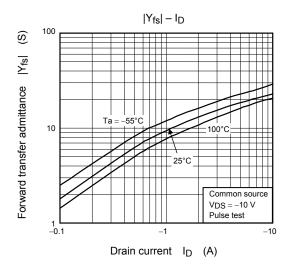
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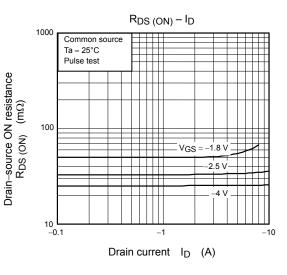




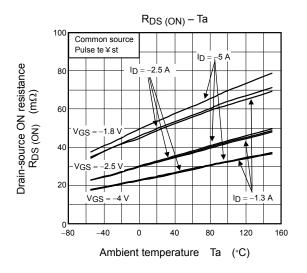


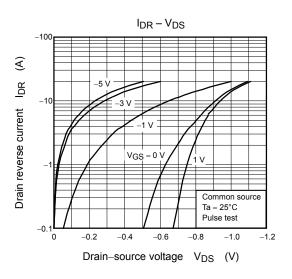


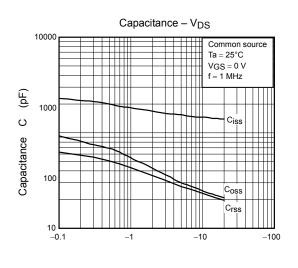




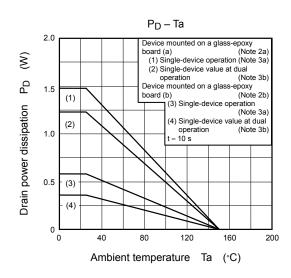
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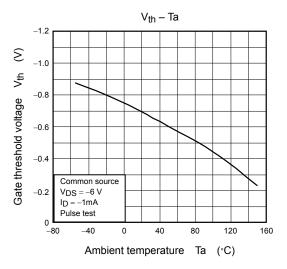


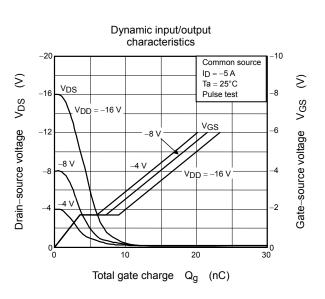


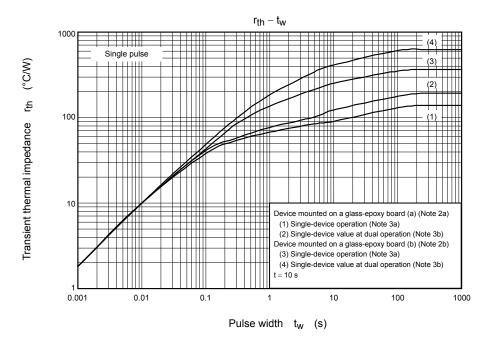


Drain–source voltage V_{DS} (V)

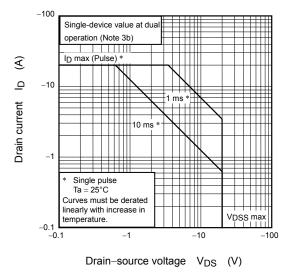








Safe operating area



RESTRICTIONS ON PRODUCT USE

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